# Flexible Termination System (FT-CAP), U2J Dielectric, 10 – 100 VDC (Commercial & Automotive Grade)



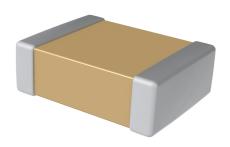
#### **Overview**

The KEMET Flexible Termination (FT-CAP) Multilayer Ceramic Capacitor in U2J dielectric incorporates a unique. flexible termination system that is integrated with KEMET's standard termination materials. A conductive silver epoxy is utilized between the base metal and nickel barrier layers of the KEMET standard termination system in order to establish pliability while maintaining terminal strength, solderability and electrical performance. This technology was developed in order to address the primary failure mode of MLCCs - flex cracks, which are typically the result of excessive tensile and shear stresses produced during board flexure and thermal cycling. Flexible termination technology inhibits the transfer of board stress to the rigid ceramic body, therefore mitigating flex cracks which can result in low insulation resistance (IR) or short circuit failures. KEMET automotive grade capacitors meet the demanding Automotive Electronics Council's AEC-Q200 qualification requirements.

Although this technology does not eliminate the potential for mechanical damage that may propagate during extreme environmental and handling conditions, it does provide superior flex performance over standard termination

systems. FT-CAP complements KEMET's Open Mode, Floating Electrode (FE-CAP), Floating Electrode with Flexible Termination (FF-CAP), and KEMET Power Solutions (KPS) product lines provide a complete portfolio of flex mitigation solutions.

Combined with the stability of U2J dielectric and designed to accommodate all capacitance requirements, these flexrobust devices are RoHS compliant, offer up to 5 mm of flex-bend capability and capacitance change limited to -750 ±20 ppm/°C from -55°C to +125°C. These devices are leadfree, RoHS and REACH compliant without exception and are capable of withstanding multiple passes through a lead-free solder reflow profile.



# **Ordering Information**

C	1206	X	104	J	3	J	A	C	TU
Ceramic	Case Size (L" x W")	Specification/ Series	Capacitance Code (pF)	Capacitance Tolerance <sup>1</sup>	Rated Voltage (VDC)	Dielectric	Failure Rate/ Design	Termination Finish	Packaging/ Grade (C-Spec)
	0603 0805 1206 1210 1812	X = Flexible Termination	Two significant digits and number of zeros.	F = ±1% G = ±2% J = ±5% K = ±10% M = ±20%	8 = 10 4 = 16 3 = 25 5 = 50 1 = 100	J = U2J	A = N/A	C = 100% Matte Sn	See "Packaging C-Spec Ordering Options Table"

<sup>&</sup>lt;sup>1</sup> Additional capacitance tolerance offerings may be available. Contact KEMET for details.



## **Packaging C-Spec Ordering Options Table**

Packaging Type <sup>1</sup>	Packaging/Grade Ordering Code (C-Spec)
Comme	rcial Grade <sup>1</sup>
Bulk Bag/Unmarked	Not required (Blank)
7" Reel/Unmarked	TU
13" Reel/Unmarked	7411 (EIA 0603 and smaller case sizes) 7210 (EIA 0805 and larger case sizes)
7" Reel/Unmarked/2 mm pitch <sup>2</sup>	7081
13" Reel/Unmarked/2 mm pitch <sup>2</sup>	7082
Automo	tive Grade <sup>3</sup>
7" Reel	AUTO
13" Reel/Unmarked	AUT07411 (EIA 0603 and smaller case sizes) AUT07210 (EIA 0805 and larger case sizes)
7" Reel/Unmarked/2 mm pitch <sup>2</sup>	3190
13" Reel/Unmarked/2 mm pitch <sup>2</sup>	3191

<sup>&</sup>lt;sup>1</sup> Default packaging is "Bulk Bag." An ordering code C-Spec is not required for "Bulk Bag" packaging.

### **Benefits**

- AEC-Q200 automotive qualified
- Low dissipation factor DF < 0.1%</li>
- · Low noise solution similar to COG
- · Low ESR and ESL
- High thermal stability
- High ripple current capability
- Preferred capacitance solution at line frequencies and into the MHz range
- Retains over 99% of nominal capacitance at full rated voltage
- · Small predictable and linear capacitance change with respect to temperature
- Operating temperature range of -55°C to +125°C
- · Capacitance up to 470 nF
- DC voltage ratings up to 100 V
- Lead (Pb)-free, RoHS and REACH compliant
- Non-polar device, minimizing installation concerns
- 100% pure matte Tin-plated termination finish allowing for excellent solderability

<sup>&</sup>lt;sup>1</sup> The terms "Marked" and "Unmarked" pertain to laser marking option of capacitors. All packaging options labeled as "Unmarked" will contain capacitors that have not been laser marked. The option to laser mark is not available on these devices. For more information see "Capacitor Marking."

<sup>&</sup>lt;sup>2</sup> The 2 mm pitch option allows for double the packaging quantity of capacitors on a given reel size. This option is limited to EIA 0603 (1608 metric) case size devices. For more information regarding 2 mm pitch option see "Tape & Reel Packaging Information."

<sup>&</sup>lt;sup>3</sup> Reeling tape options (paper or plastic) are dependent on capacitor case size (I" x w") and thickness dimensions. See "Chip Thickness/Tape & Reel Packaging Quantities" and "Tape & Reel Packaging Information."

<sup>&</sup>lt;sup>3</sup> For additional information regarding "AUTO" C-Spec options, see "Automotive C-Spec Information."

<sup>&</sup>lt;sup>3</sup> All automotive packaging C-Specs listed exclude the option to laser mark components. The option to laser mark <u>is not available</u> on these devices. For more information see "Capacitor Marking."



## **Automotive C-Spec Information**

KEMET automotive grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. These products are supported by a Product Change Notification (PCN) and Production Part Approval Process warrant (PPAP).

Automotive products offered through our distribution channel have been assigned an inclusive ordering code C-Spec, "AUTO." This C-Spec was developed in order to better serve small and medium-sized companies that prefer an automotive grade component without the requirement to submit a customer Source Controlled Drawing (SCD) or specification for review by a KEMET engineering specialist. This C-Spec is therefore not intended for use by KEMET OEM automotive customers and are not granted the same "privileges" as other automotive C-Specs. Customer PCN approval and PPAP request levels are limited (see details below.)

#### **Product Change Notification (PCN)**

The KEMET product change notification system is used to communicate primarily the following types of changes:

- Product/process changes that affect product form, fit, function, and/or reliability
- · Changes in manufacturing site
- Product obsolescence

KEMET Automotive	Customer Notifica	tion Due To:	Days Prior To		
C-Spec	Process/Product change	Obsolescence*	Implementation		
KEMET assigned <sup>1</sup>	Yes (with approval and sign off)	Yes	180 days minimum		
AUT0	Yes (without approval)	Yes	90 days minimum		

<sup>&</sup>lt;sup>1</sup> KEMET assigned C-Specs require the submittal of a customer SCD or customer specification for review. For additional information contact KEMET.

#### **Production Part Approval Process (PPAP)**

The purpose of the Production Part Approval Process is:

- To ensure that supplier can meet the manufacturability and quality requirements for the purchased parts.
- To provide the evidence that all customer engineering design records and specification requirements are properly understood and fulfilled by the manufacturing organization.
- To demonstrate that the established manufacturing process has the potential to produce the part.

KEMET Automotive	I	PPAP (Product	Part Approval	Process) Leve	I
C-Spec	1	2	3	4	5
KEMET assigned <sup>1</sup>	•	•	•	•	•
AUT0			0		

<sup>&</sup>lt;sup>1</sup> KEMET assigned C-Specs require the submittal of a customer SCD or customer specification for review. For additional information contact KEMET.

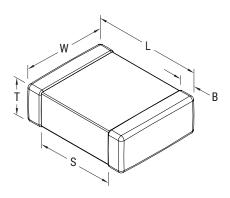
- Part number specific PPAP available
- Product family PPAP only



## **Applications**

Typical applications include critical timing, tuning, circuits requiring low loss, circuits with pulse, high current, decoupling, bypass, filtering, transient voltage suppression and blocking, as well as energy storage in critical and safety relevant circuits without (integrated) current limitation, including those subject to high levels of board flexure or temperature cycling.

# **Dimensions - Millimeters (Inches)**



EIA Size Code	Metric Size Code	L Length	W Width	T Thickness	B Bandwidth	S Separation Minimum	Mounting Technique
0603	1608	1.60 (0.063)	0.80 (0.032)		0.45 (0.018)	0.58 (0.023)	
0003	1000	± 0.17 (0.007)	± 0.15 (0.006)		± 0.15 (0.006)	0.36 (0.023)	Solder wave
0805	2012	2.00 (0.079)	1.25 (0.049)		0.50 (0.02)	0.75 (0.030)	
0003	2012	± 0.30 (0.012)	± 0.30 (0.012)		± 0.25 (0.010)	0.75 (0.050)	or Solder reflow
1206	3216	3.30 (0.130)	1.60 (0.063)	See Table 2	0.60 (0.024)		Solder reliow
1200	3210	± 0.40 (0.016)	± 0.35(0.013)	for thickness	± 0.25 (0.010)		
1210	3225	3.30 (0.130)	2.60(0.102)		0.60 (0.024)	N/A	
1210	3223	± 0.40 (0.016)	± 0.30(0.012)		± 0.25 (0.010)	IN/A	Solder reflow
1812	4532	4.50 (0.178)	3.20 (0.126)		0.70 (0.028)		only
1012	4332	± 0.40 (0.016)	± 0.30 (0.012)		± 0.35 (0.014)		_



## **Qualification/Certification**

Commercial grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance & Reliability.

Automotive grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in the document AEC-Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC-Q200, please visit their website at www.aecouncil.com.

## **Environmental Compliance**

Lead (Pb)-free, RoHS, and REACH compliant without exemptions.

## **Electrical Parameters/Characteristics**

Item	Parameters/Characteristics
Operating Temperature Range	-55°C to +125°C
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	-750 ±120 ppm/°C
Aging Rate (Maximum % Capacitance Loss/Decade Hour)	0.1%
Dielectric Withstanding Voltage (DWV)	250% of rated voltage (5 ±1 seconds and charge/discharge not exceeding 50 mA)
Dissipation Factor (DF) Maximum Limit at 25°C	0.1%
Insulation Resistance (IR) Limit at 25°C	1,000 MΩ μF or 100 GΩ (Rated voltage applied for 120 ±5 seconds at 25°C)

To obtain IR limit, divide  $M\Omega$ - $\mu$ F value by the capacitance and compare to  $G\Omega$  limit. Select the lower of the two limits. Capacitance and dissipation factor (DF) measured under the following conditions:

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 and Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON."

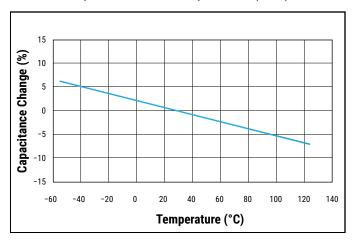
<sup>1</sup> MHz ±100 kHz and 1.0 ±0.2  $V_{rms}$  if capacitance  $\leq$  1,000 pF

<sup>1</sup> kHz  $\pm$ 50 Hz and 1.0  $\pm$ 0.2 V<sub>rms</sub> if capacitance > 1,000 pF



# **Electrical Characteristics (Typical)**

## Capacitance vs. Temperature (TCC)



## **Post Environmental Limits**

F	High Temperature Life, Biased Humidity, Moisture Resistance											
Dielectric	Rated DC Voltage	Capacitance Value	Dissipation Factor (Maximum %)	Capacitance Shift	Insulation Resistance							
U2J	All	All	0.5	0.3% or ±0.25 pF	10% of Initial limit							



# Table 1A - Capacitance Range/Selection Waterfall (0603 - 1812 Case Sizes)

1,000 pF 102 1,100 pF 112 1,200 pF 122 1,300 pF 152 1,500 pF 152 1,600 pF 202 2,200 pF 202 2,400 pF 272 3,000 pF 302 3,300 pF 302 3,000 pF 302 3,000 pF 302 3,000 pF 302 3,000 pF 302 4,700 pF 432 4,700 pF 512 5,600 pF 622 6,800 pF 622 6,800 pF 622 6,800 pF 752 8,200 pF 822 9,100 pF 103 12,000 pF 103 12,000 pF 123 15,000 pF 153 18,000 pF 153 18,000 pF 123 15,000 pF 153 18,000 pF 153 18,000 pF 153 18,000 pF 153 33,000 pF 333 39,000 pF 333 39,000 pF 473 56,000 pF 688	102 112 122 132 152 162 182 202 222 242 272 302 332 362	Note	G J K M G J K M G J K M G J K M G J K M G J K M G J K M G J K M G J K M G J K M G J K M G J K M	8 OF CF	CF CF CF CF CF CF CF CF	CF CF CF CF CF CF CF	CF CF CF CF CF	10 8	4 92	3 Produ See	5 Ct Ava Table	8 2 ilabili 2 for (	4 ⊈ ty and Chip T	3 52 I Chip Thickn	5 C Thick ess Di	eness (	4 9 Codes ions	52 8	5 09	100	10 8	4 92	22 ε
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6,200 pF 622 6,800 pF 682 7,500 pF 752 8,200 pF 822 9,100 pF 912 10,000 pF 123 15,000 pF 153 18,000 pF 183 22,000 pF 223 27,000 pF 273 33,000 pF 333 39,000 pF 393 39,000 pF 473 56,000 pF 563 68,000 pF 683 82,000 pF 823	562		J K M	CF	CF	CF	CF	DC	DC	DC	DC												
7,500 pF 752 8,200 pF 822 9,100 pF 912 10,000 pF 103 12,000 pF 153 15,000 pF 153 18,000 pF 223 27,000 pF 223 27,000 pF 27,000 pF 333 39,000 pF 393 47,000 pF 473 56,000 pF 563 68,000 pF 683 82,000 pF 823	622			CF	CF	CF	CF	DC	DC	DC	DC												
8,200 pF 9,100 pF 912 10,000 pF 103 12,000 pF 153 15,000 pF 153 18,000 pF 223 27,000 pF 223 27,000 pF 27,000 pF 333 39,000 pF 393 47,000 pF 473 56,000 pF 563 68,000 pF 683	682	582 F (	J K M	CF	CF	CF	CF	DC	DC	DC	DC												
9,100 pF 912 10,000 pF 103 12,000 pF 123 15,000 pF 153 18,000 pF 223 22,000 pF 223 27,000 pF 273 33,000 pF 333 39,000 pF 473 56,000 pF 563 68,000 pF 683 82,000 pF 823	752	752   F (	G J K M	CF	CF	CF	CF	DC	DC	DC	DC												
10,000 pF 103 12,000 pF 123 15,000 pF 153 18,000 pF 183 22,000 pF 223 27,000 pF 273 33,000 pF 393 39,000 pF 473 56,000 pF 563 68,000 pF 683 82,000 pF 823	822			CF	CF	CF	CF	DC	DC	DC	DC												
12,000 pF 123 15,000 pF 153 18,000 pF 183 22,000 pF 223 27,000 pF 273 33,000 pF 393 39,000 pF 393 47,000 pF 473 56,000 pF 563 68,000 pF 683 82,000 pF 823	912			CF	CF	CF	CF	DC	DC	DC	DC												
15,000 pF 153 18,000 pF 183 22,000 pF 223 27,000 pF 273 33,000 pF 333 39,000 pF 393 47,000 pF 473 56,000 pF 563 68,000 pF 683 82,000 pF 823				CF	CF	CF	CF	DC	DC	DC	DC	EB	EB	EB	EB	FB	FB	FB	FB	FB			
18,000 pF 183 22,000 pF 223 27,000 pF 273 33,000 pF 333 39,000 pF 393 47,000 pF 473 56,000 pF 563 68,000 pF 683 82,000 pF 823				CF	CF	CF		DC	DC	DC	DC	EB	EB	EB	EB	FB	FB	FB	FB	FB			
22,000 pF 223 27,000 pF 273 33,000 pF 333 39,000 pF 393 47,000 pF 473 56,000 pF 563 68,000 pF 683 82,000 pF 823				CF	CF	CF		DC	DC	DC	DC	EB	EB	EB	EB	FB	FB	FB	FB	FB			
27,000 pF 273 33,000 pF 333 39,000 pF 393 47,000 pF 473 56,000 pF 563 68,000 pF 683 82,000 pF 823								DC DC	DC DC	DC DC	DC DD	EB EB	EB EB	EB EB	EB EB	FB FB	FB FB	FB FB	FB FB	FB FB			
33,000 pF 333 39,000 pF 393 47,000 pF 473 56,000 pF 563 68,000 pF 683 82,000 pF 823								DD	DD	DD	DD	EB	EB	EB	EB	FB	FB	FB	FB FB	FB			
39,000 pF 393 47,000 pF 473 56,000 pF 563 68,000 pF 683 82,000 pF 823								DD	DD	DD	DG	EB	EB	EB	EB	FB	FB	FB	FB	FC	GB	GB	GB
47,000 pF 473 56,000 pF 563 68,000 pF 683 82,000 pF 823								DG	DG	DG	DG	EB	EB	EB	EB	FB	FB	FB	FB	FC	GB	GB	GB
56,000 pF 563 68,000 pF 683 82,000 pF 823								DG	DG	DG	DG	EB	EB	EB	EB	FB	FB	FB	FB	FC	GB	GB	GB
68,000 pF 683 82,000 pF 823	563							DG	DG	DG		EB	EB	EB	EC	FB	FB	FB	FB	FE	GB	GB	GB
	683											EC	EC	EC	EC	FB	FB	FB	FB	FG	GB	GB	GB
100,000 pF 104	823											EC	EC	EC	EE	FB	FB	FB	FB	FG	GB	GB	GB
	104											EC	EC	EC	EF	FB	FB	FB	FC	FG	GB	GB	GB
												EF	EP	EF	EH	FC	FC	FC	FE	FH	GB	GB	GB
	124		J K M									EF	EF	EF	EH	FE	FE	FE	FG	FT	GB	GB	GB
	124 154		JKM									EH	EH	EH		FG	FG	FG	FG	FK	GB	GB	GB
	124 154 184	224     F (	JKM									EH	EH	EH		FG	FG	FG	FH		GB	GB	GB
	124 154 184 224	274   F (	JKM													FH	FH	FH	FM		GB	GB	GB
	124 154 184 224 274		G J K M G J K M													FM	FM	FM			GC GH	GC GH	GC
	124 154 184 224 274 334		J K M																		GK	GK	GH GK
474,000 μι 474	124 154 184 224 274 334 394	174       F   (		2	16	25	50	10	16	25	50	9	16	25	20	10	9	25	20	100	97	96	25
Capacitance Cap Co	124 154 184 224 274 334		itage (VDC)	8	4	3	5	8 -	4	3	5	8	4	3	5	8	4	3	<u>بر</u>	1	8	4	3
Capacitance Cap Co	124 154 184 224 274 334 394	Rated Vo	ge Code	۳	C06		, v		C08				C12		•	,	-	•	•	_ '	C		



## Table 2A - Chip Thickness/Tape & Reel Packaging Quantities

Thickness	Case	Thickness ±	Paper Q	uantity <sup>1</sup>	Plastic (	Quantity	
Code	Size <sup>1</sup>	Range (mm)	7" Reel	13" Reel	7" Reel	13" Reel	
CF	0603	0.80 ± 0.07*	4,000	15,000	0	0	
DC	0805	0.78 ± 0.10	0	0	4,000	10,000	
DD	0805	0.90 ± 0.10	0	0	4,000	10,000	
DG	0805	1.25 ± 0.15	0	0	2,500	10,000	
EB	1206	0.78 ± 0.10	4,000	10,000	4,000	10,000	
EC	1206	0.90 ± 0.10	0	0	4,000	10,000	
EE	1206	1.10 ± 0.10	0	0	2,500	10,000	
EF	1206	1.20 ± 0.15	0	0	2,500	10,000	
EP	1206	1.20 ± 0.20	0	0	2,500	10,000	
EH	1206	1.60 ± 0.20	0	0	2,000	8,000	
FB	1210	0.78 ± 0.10	0	0	4,000	10,000	
FC	1210	0.90 ± 0.10	0	0	4,000	10,000	
FE	1210	1.00 ± 0.10	0	0	2,500	10,000	
FG	1210	1.25 ± 0.15	0	0	2,500	10,000	
FH	1210	1.55 ± 0.15	0	0	2,000	8,000	
FM	1210	1.70 ± 0.20	0	0	2,000	8,000	
FT	1210	1.90 ± 0.20	0	0	2,000	8,000	
FK	1210	2.10 ± 0.20	0	0	2,000	8,000	
GB	1812	1.00 ± 0.10	0	0	1,000	4,000	
GC	1812	1.10 ± 0.10	0	0	1,000	4,000	
GH	1812	1.40 ± 0.15	0	0	1,000	4,000	
GK	1812	1.60 ± 0.20	0	0	1,000	4,000	
Thickness	Case	Thickness ±	7" Reel	13" Reel	7" Reel	13" Reel	
Code	Size <sup>1</sup>	Range (mm)	Paper Q	uantity <sup>1</sup>	Plastic Quantity		

Package quantity based on finished chip thickness specifications.

# Table 2B - Bulk Packaging Quantities

Dookoa	ing Type	Loose Pa	ackaging				
Packagi	ing Type	Bulk Bag (default)					
Packagin	g C-Spec <sup>1</sup>	N/A²					
Case	Size	Packaging Quantities (pieces/unit packaging					
EIA (in)	Metric (mm)	Minimum	Maximum				
0603	1608						
0805	2012		50,000				
1206	3216	1	30,000				
1210	3225						
1812	4532		20,000				

<sup>&</sup>lt;sup>1</sup> The "Packaging C-Spec" is a 4 to 8 digit code which identifies the packaging type and/or product grade. When ordering, the proper code must be included in the 15th through 22nd character positions of the ordering code. See "Ordering Information" section of this document for further details. Commercial Grade product ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging. Contact KEMET if you require a bulk bag packaging option for automotive grade products.

<sup>&</sup>lt;sup>1</sup> If ordering using the 2 mm Tape & Reel pitch option, the packaging quantity outlined in the table above will be doubled. This option is limited to EIA 0603 (1608 metric) case size devices. For more information regarding 2 mm pitch option see "Tape & Reel Packaging Information."

<sup>&</sup>lt;sup>2</sup> A packaging C-Spec (see note 1 above) is not required for "Bulk Bag" packaging (excluding Anti-Static Bulk Bag and automotive grade products). The 15th through 22nd character positions of the ordering code should be left blank. All product ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging.



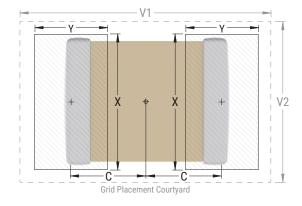
## Table 3 - Chip Capacitor Land Pattern Design Recommendations per IPC-7351 (mm)

EIA Size Code	Metric Size Code		ı	Density Level B: Median (Nominal) Land Protrusion (mm)					Density Level C: Minimum (Least) Land Protrusion (mm)							
Code	Code	С	Y	X	<b>V</b> 1	V2	С	Y	X	V1	V2	С	Y	X	V1	V2
0603	1608	0.85	1.25	1.10	4.00	2.10	0.75	1.05	1.00	3.10	1.50	0.65	0.85	0.90	2.40	1.20
0805	2012	0.99	1.44	1.66	4.47	2.71	0.89	1.24	1.56	3.57	2.11	0.79	1.04	1.46	2.42	1.81
1206	3216	1.59	1.62	2.06	5.85	3.06	1.49	1.42	1.96	4.95	2.46	1.39	1.22	1.86	4.25	2.16
1210	3225	1.59	1.62	3.01	5.90	4.01	1.49	1.42	2.91	4.95	3.41	1.39	1.22	2.81	4.25	3.11
1812	4532	2.10	1.80	3.60	7.00	4.60	2.00	1.60	3.50	6.10	4.00	1.90	1.40	3.40	5.40	3.70

**Density Level A:** For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes. KEMET only recommends wave soldering of EIA 0603, 0805, and 1206 case sizes.

**Density Level B:** For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC-7351).

Image below based on Density Level B for an EIA 1210 case size.





## **Soldering Process**

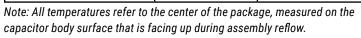
#### **Recommended Soldering Technique:**

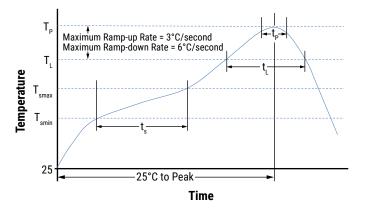
- Solder wave or solder reflow for EIA case sizes 0603, 0805 and 1206
- · All other EIA case sizes are limited to solder reflow only

#### **Recommended Reflow Soldering Profile:**

The KEMET families of surface mount multilayer ceramic capacitors (SMD MLCCs) are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. The KEMET recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020 standard for moisture sensitivity testing. These devices can safely withstand a maximum of three reflow passes at these conditions.

Profile Feature	Terminat	ion Finish		
1 Tome Teature	SnPb	100% Matte Sn		
Preheat/Soak				
Temperature Minimum (T <sub>Smin</sub> )	100°C	150°C		
Temperature Maximum (T <sub>Smax</sub> )	150°C	200°C		
Time ( $t_s$ ) from $T_{Smin}$ to $T_{Smax}$	60 – 120 seconds	60 - 120 seconds		
Ramp-Up Rate (T <sub>L</sub> to T <sub>P</sub> )	3°C/second maximum	3°C/second maximum		
Liquidous Temperature (T <sub>L</sub> )	183°C	217°C		
Time Above Liquidous (t <sub>L</sub> )	60 - 150 seconds	60 - 150 seconds		
Peak Temperature (T <sub>P</sub> )	235°C	260°C		
Time Within 5°C of Maximum Peak Temperature (t <sub>p</sub> )	20 seconds maximum	30 seconds maximum		
Ramp-Down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second maximum	6°C/second maximum		
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum		







## Table 4 - Performance & Reliability: Test Methods and Conditions

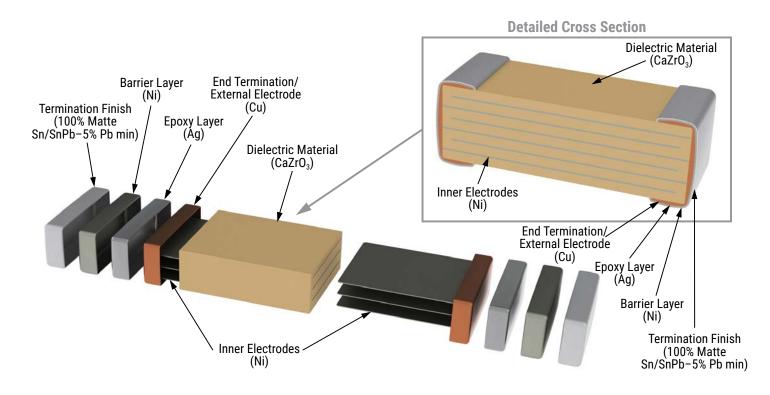
Stress	Reference		Test or Inspection	Method			
			Package Size (L" x W")	Force	Duration		
Terminal Strength	JIS-C-6429	Appendix 1, Note:	0402	5 N (0.51 kg)			
		,	0603	10 N (1.02 kg)	60 seconds		
			≥ 0805	18 N (1.83 kg)			
Board Flex	JIS-C-6429	Appendix 2, Note: 3.0 mm	Appendix 2, Note: 3.0 mm (minimum)				
		Magnification 50 X Condi	tions:				
Caldanahilitu	L CTD 000	a) Method B, 4 hou	s at 155°C, dry heat at 235	5°C			
Solderability	J-STD-002	b) Method B, at 215°C, category 3					
		c) Method D, at 260	°C, category 3				
Temperature Cycling	JESD22 Method JA-104	1,000 cycles (-55°C to +125°C). Measurement at 24 hours ±4 hours after test conclusion.					
D: 111 :15	MII OTD 000 M .I. 1400	Load Humidity: 1,000 hou Measurement at 24 hours	y: 1,000 hours 85°C/85% RH and rated voltage. Add 100 K ohm resistor. at 24 hours ±4 hours after test conclusion.				
Biased Humidity	MIL-STD-202 Method 103	Low Volt Humidity: 1,000 Measurement at 24 hours			hm resistor.		
Moisture Resistance	MIL-STD-202 Method 106	t = 24 hours/cycle. Steps 7a and 7b not required. Measurement at 24 hours ±4 hours after test conclusion.					
Thermal Shock	MIL-STD-202 Method 107	-55°C/+125°C. Note: Number of cycles required – 300. Maximum transfer time – 20 seconds. Dwell time – 15 minutes. Air – air.					
High Temperature Life	MIL-STD-202 Method 108/EIA -198	1,000 hours at 125°C with 2 X rated voltage applied.					
Storage Life	MIL-STD-202 Method 108	125°C, 0 VDC for 1,000 ho	urs.				
Vibration	MIL-STD-202 Method 204	5 G's for 20 minutes, 12 cycles each of 3 orientations. Note: Use 8" X 5" PCB 0.031" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10 – 2,000 Hz					
Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213, Condition F.					
Resistance to Solvents	MIL-STD-202 Method 215	Add aqueous wash chemi	Add aqueous wash chemical, OKEM clean or equivalent.				

# **Storage and Handling**

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature – reels may soften or warp, and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 1.5 years of receipt.



#### Construction



## **Capacitor Marking (Optional):**

Laser marking option is not available on:

- · COG, U2J, Ultra Stable X8R and Y5V dielectric devices
- · EIA 0402 case size devices
- EIA 0603 case size devices with flexible termination option.
- · KPS commercial and automotive grade stacked devices.

These capacitors are supplied unmarked only.



## **Tape & Reel Packaging Information**

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12 and 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.

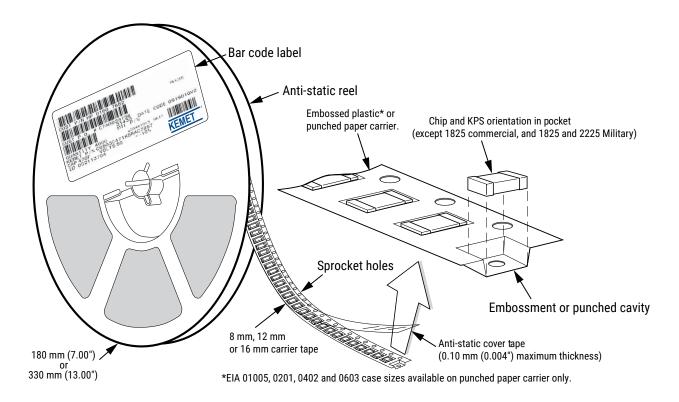


Table 5 - Carrier Tape Configuration, Embossed Plastic & Punched Paper (mm)

	Tape	Embosse	ed Plastic	Punched Paper	
<b>EIA Case Size</b>	Size	7" Reel	13" Reel	7" Reel	13" Reel
	(W)*	Pitch (P <sub>1</sub> )*		Pitch (P₁)*	
01005 - 0402	8			2	2
0603	8			2/4	2/4 /
0805	8	4	4	4	4
1206 - 1210	8	4	4	4	4
1805 - 1808	12	4	4		
≥ 1812	12	8	8		
KPS 1210	12	8	8		
KPS 1812 and 2220	16	12	12		
Array 0612	8	4	4		

<sup>\*</sup>Refer to Figures 1 and 2 for W and  $P_1$  carrier tape reference locations.

New 2 mm Pitch Reel Options*	•
------------------------------	---

	Packaging Ordering Code (C-Spec)	Packaging Type/Options
•	C-3190	Automotive grade 7" reel unmarked
	C-3191	Automotive grade 13" reel unmarked
	C-7081	Commercial grade 7" reel unmarked
	C-7082	Commercial grade 13" reel unmarked

<sup>\* 2</sup> mm pitch reel only available for 0603 EIA case size. 2 mm pitch reel for 0805 EIA case size under development.

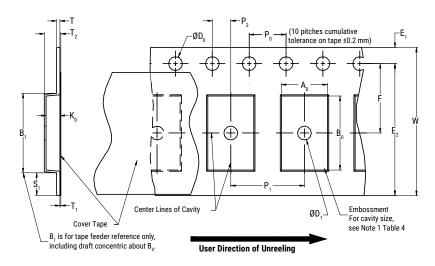
#### Benefits of Changing from 4 mm to 2 mm Pitching Spacing

- · Lower placement costs.
- Double the parts on each reel results in fewer reel changes and increased efficiency.
- Fewer reels result in lower packaging, shipping and storage costs, reducing waste.

<sup>\*</sup>Refer to Tables 6 and 7 for tolerance specifications.



## Figure 1 – Embossed (Plastic) Carrier Tape Dimensions



## **Table 6 – Embossed (Plastic) Carrier Tape Dimensions**

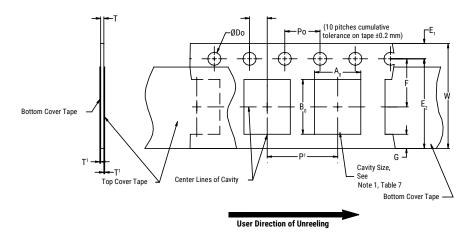
Metric will govern

Constant Dimensions — Millimeters (Inches)									
Tape Size	D <sub>0</sub>	D <sub>1</sub> Minimum Note 1	E <sub>1</sub>	P <sub>0</sub>	P <sub>2</sub>	R Reference Note 2	S <sub>1</sub> Minimum Note 3	T Maximum	T <sub>1</sub> Maximum
8 mm		1.0 (0.039)				25.0 (0.984)			
12 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.5	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	30	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)
16 mm		(0.059)				(1.181)			
		1	Variable Dime	ensions — Mil	limeters (Inch	ies)			
Tape Size	Tape Size Pitch B <sub>1</sub> Maximum E <sub>2</sub> F P <sub>1</sub> T <sub>2</sub> W Maximum A <sub>0</sub> ,B <sub>0</sub> & K <sub>0</sub>						& K <sub>0</sub>		
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)		
12 mm	Single (4 mm) and double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)	Not	te 5
16 mm	Triple (12 mm)	12.1 (0.476)	14.25 (0.561)	7.5 ±0.05 (0.138 ±0.002)	12.0 ±0.10 (0.157 ±0.004)	4.6 (0.181)	16.3 (0.642)		

- 1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of the embossment location and the hole location shall be applied independently of each other.
- 2. The tape with or without components shall pass around R without damage (see Figure 6.)
- 3. If  $S_1 < 1.0$  mm, there may not be enough area for a cover tape to be properly applied (see EIA Standard 481, paragraph 4.3, section b.)
- 4. B, dimension is a reference dimension for tape feeder clearance only.
- 5. The cavity defined by  $A_{\alpha}$ ,  $B_{\alpha}$  and  $K_{\alpha}$  shall surround the component with sufficient clearance that:
  - (a) the component does not protrude above the top surface of the carrier tape.
  - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
  - (c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 3.)
  - (d) lateral movement of the component is restricted to 0.5 mm maximum for 8 and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 4.)
  - (e) for KPS product,  $A_0$  and  $B_0$  are measured on a plane 0.3 mm above the bottom of the pocket.
  - (f) see addendum in EIA Standard 481 for standards relating to more precise taping requirements.



## Figure 2 - Punched (Paper) Carrier Tape Dimensions



## **Table 7 - Punched (Paper) Carrier Tape Dimensions**

Metric will govern

Constant Dimensions — Millimeters (Inches)							
Tape Size	D <sub>o</sub>	E <sub>1</sub>	P <sub>0</sub>	P <sub>2</sub>	T <sub>1</sub> Maximum	G Minimum	R Reference Note 2
8 mm	1.5 +0.10 -0.0 (0.059 +0.004 -0.0)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	0.10 (0.004) maximum	0.75 (0.030)	25 (0.984)
	Variable Dimensions — Millimeters (Inches)						
Tape Size	Pitch	E2 Minimum	F	P <sub>1</sub>	T Maximum	W Maximum	$A_0^{}B_0^{}$
8 mm	Half (2 mm)	6.25	3.5 ±0.05	2.0 ±0.05 (0.079 ±0.002)	1.1	8.3 (0.327)	Note 1
8 mm	Single (4 mm)	(0.246)	(0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	(0.098)	8.3 (0.327)	Note I

- 1. The cavity defined by  $A_{n}$ ,  $B_{n}$  and T shall surround the component with sufficient clearance that:
  - a) the component does not protrude beyond either surface of the carrier tape.
  - b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
  - c) rotation of the component is limited to 20° maximum (see Figure 3.)
  - d) lateral movement of the component is restricted to 0.5 mm maximum (see Figure 4.)
  - e) see addendum in EIA Standard 481 for standards relating to more precise taping requirements.
- 2. The tape with or without components shall pass around R without damage (see Figure 6.)



## **Packaging Information Performance Notes**

1. Cover Tape Break Force: 1.0 kg minimum.

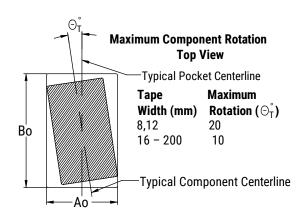
2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

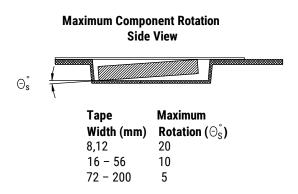
Tape Width	Peel Strength
8 mm	0.1 to 1.0 newton (10 to 100 gf)
12 and 16 mm	0.1 to 1.3 newton (10 to 130 gf)

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ±10 mm/minute.

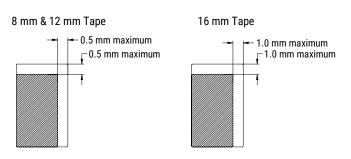
**3. Labeling:** Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624*.

## **Figure 3 – Maximum Component Rotation**





# Figure 4 - Maximum Lateral Movement



# Figure 5 - Bending Radius

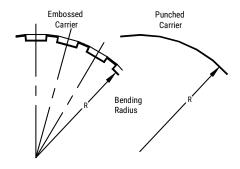
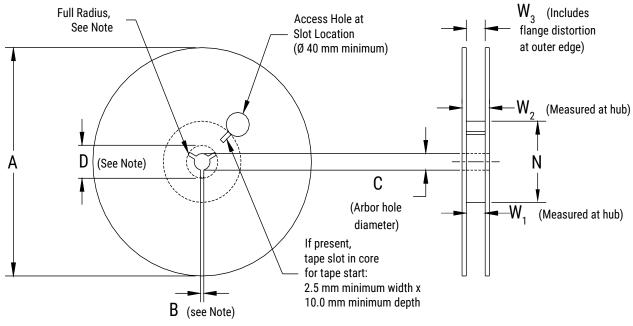




Figure 6 - Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

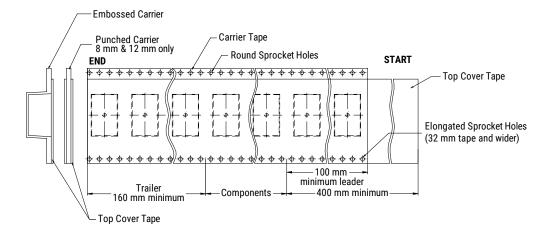
## **Table 8 - Reel Dimensions**

Metric will govern

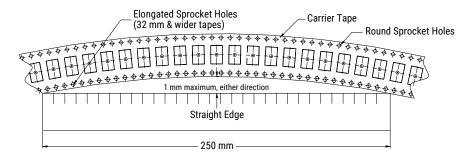
Constant Dimensions — Millimeters (Inches)						
Tape Size	A	B Minimum	С	D Minimum		
8 mm	178 ±0.20					
12 mm	(7.008 ±0.008) or	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)		
16 mm	330 ±0.20 (13.000 ±0.008)	, ,	,			
	Variable	Dimensions — Millimeter	rs (Inches)			
Tape Size	N Minimum	W <sub>1</sub>	W <sub>2</sub> Maximum	W <sub>3</sub>		
8 mm		8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)			
12 mm	50 (1.969)	12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	Shall accommodate tape width without interference		
16 mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)			



## Figure 7 - Tape Leader & Trailer Dimensions



## Figure 8 - Maximum Camber





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C0603X162G3JACAUT0	C1210X223G3JACAUT	O C0603X122J5JACAUTO	<u>C0603X302G8JACAUTO</u>
C1812X333M3JACAUTO	C1206X393J5JACAUTO	C0603X362K4JACAUTO	C0805X822K3JACAUTO
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C1206X473K8JACAUTO	C1812X124F3JACAUTO	C0603X103F3JACAUTO	C1210X184J3JACAUTO
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